



# Product Change Notification

## 112520 - 00

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# Product Change Notification

**Change Notification #:** 112520 - 00  
**Change Title:** Intel® Server System R2308GZ4GC  
PCN 112520-00, Product Design  
Update Rear Panel, Add Ground Studs  
**Date of Publication:** August 20, 2013

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material *:</b>	Sep 04, 2013
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*\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

## Description of Change to the Customer:

Intel has implemented the following changes on Intel® Server System R2308GZ4GC:

1. Adding a small cut-out to the system rear panel to provide better clearance for latches on network cables plugging into the Dual Port Intel® X540 10GbE I/O Module AXX10GBTWLIOM.
2. Adding two ground studs on the system rear panel for future use (see Figure 1 below).



Figure 1: The ground studs

### **Customer Impact of Change and Recommended Action:**

Intel recommends that the customer perform a standard level of evaluation as updated product become available.

### **Products Affected / Intel Ordering Codes:**

<b>EMEA SKU</b>			
<b>Product Code</b>	<b>MM#</b>	<b>Pre Change TA</b>	<b>Post Change TA</b>
R2308GZ4GC	917004	G52105-005	G52105-006

### **PCN Revision History:**

**Date of Revision:**

August 20, 2013

**Revision Number:**

00

**Reason:**

Originally Published PCN